

Serial E²PROM

TYPICAL FEATURES

- 2.7V to 5.5V Power Supply
- Low Power CMOS
 - Active Read Current Less Than 1 mA
 - Active Write Current Less Than 3 mA
 - Standby Current Less Than 50 μ A
- Internally Organized 1024 x 8
- 2 Wire Serial Interface
 - Bidirectional Data Transfer Protocol
- Sixteen Byte Page Write Mode
 - Minimizes Total Write Time Per Byte
- Self Timed Write Cycle
 - Typical Write Cycle Time of 5 ms
- High Reliability
 - Endurance: 100,000 Cycles
 - Data Retention: 100 Years
- 8 Pin Mini-DIP, 8 Pin SOIC and 14 Pin SOIC Packages

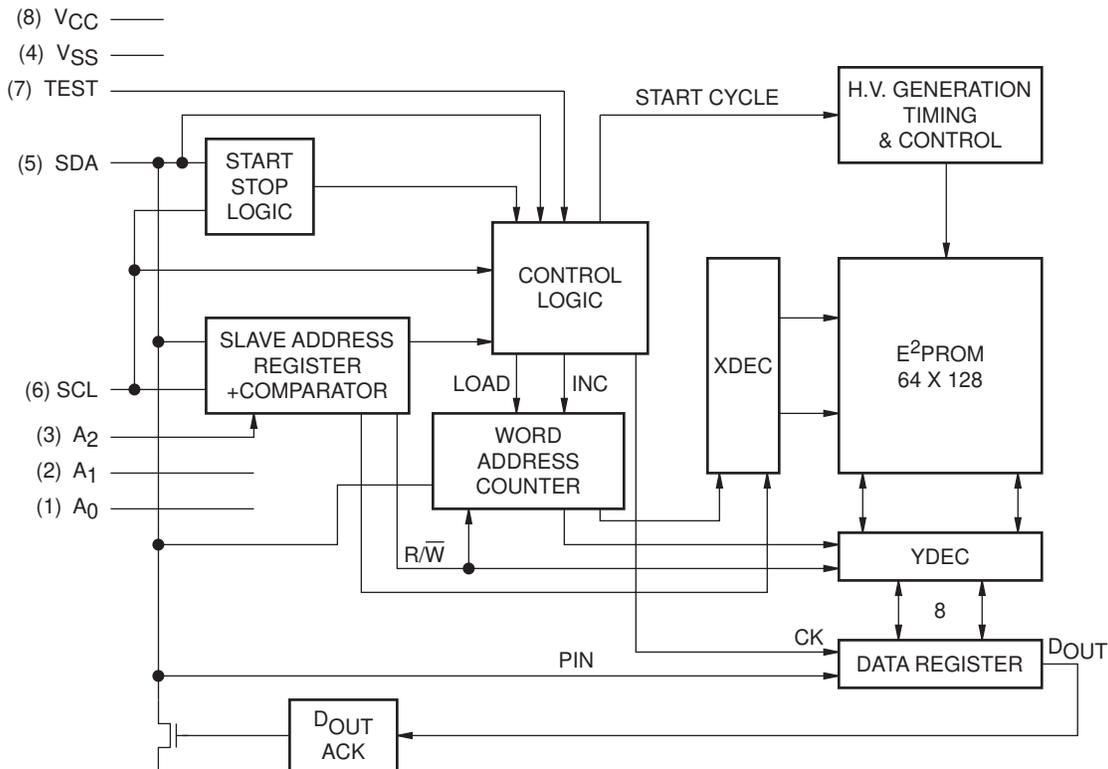
DESCRIPTION

The X24C08 is a CMOS 8,192 bit serial E²PROM, internally organized 1024 x 8. The X24C08 features a serial interface and software protocol allowing operation on a simple two wire bus.

The X24C08 is fabricated with Xicor's advanced CMOS Textured Poly Floating Gate Technology.

The X24C08 utilizes Xicor's proprietary Direct Write™ cell providing a minimum endurance of 100,000 cycles and a minimum data retention of 100 years.

FUNCTIONAL DIAGRAM



3842 FHD F01

X24C08

PIN DESCRIPTIONS

Serial Clock (SCL)

The SCL input is used to clock all data into and out of the device.

Serial Data (SDA)

SDA is a bidirectional pin used to transfer data into and out of the device. It is an open drain output and may be wire-ORed with any number of open drain or open collector outputs.

An open drain output requires the use of a pull-up resistor. For selecting typical values, refer to the Pull-Up Resistor selection graph at the end of this data sheet.

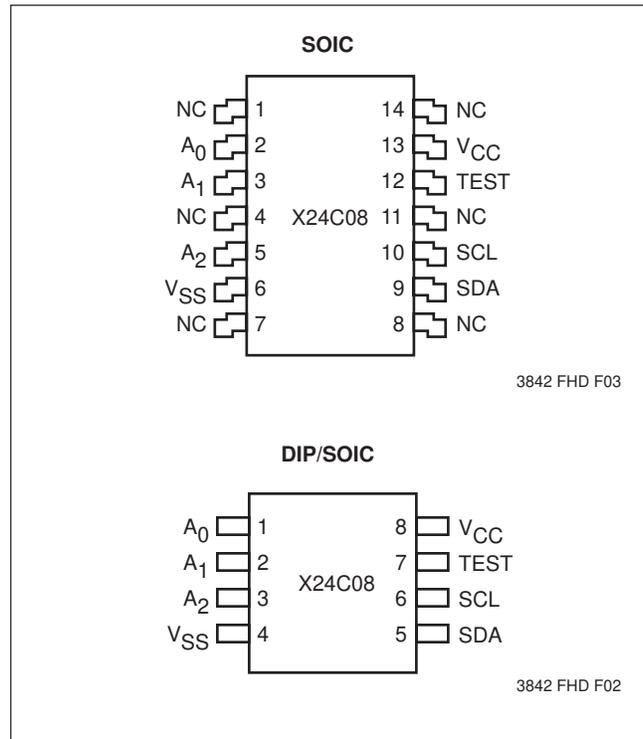
Address (A₀, A₁)

A₀ and A₁ are unused by the X24C08; however, they must be tied to V_{SS} to insure proper device operation.

Address (A₂)

The A₂ input is used to set the appropriate bit of the seven bit slave address. This input can be used static or actively driven. If used statically, it must be tied to V_{SS} or V_{CC} as appropriate. If actively driven, it must be driven to V_{SS} or to V_{CC}.

PIN CONFIGURATION



PIN NAMES

Symbol	Description
A ₀ -A ₂	Address Inputs
SDA	Serial Data
SCL	Serial Clock
TEST	Hold at V _{SS}
V _{SS}	Ground
V _{CC}	Supply Voltage
NC	No Connect

3842 PGM T01

X24C08

DEVICE OPERATION

The X24C08 supports a bidirectional bus oriented protocol. The protocol defines any device that sends data onto the bus as a transmitter, and the receiving device as the receiver. The device controlling the transfer is a master and the device being controlled is the slave. The master will always initiate data transfers, and provide the clock for both transmit and receive operations. Therefore, the X24C08 will be considered a slave in all applications.

Clock and Data Conventions

Data states on the SDA line can change only during SCL LOW. SDA state changes during SCL HIGH are reserved for indicating start and stop conditions. Refer to Figures 1 and 2.

Start Condition

All commands are preceded by the start condition, which is a HIGH to LOW transition of SDA when SCL is HIGH. The X24C08 continuously monitors the SDA and SCL lines for the start condition and will not respond to any command until this condition has been met.

Stop Condition

All communications must be terminated by a stop condition, which is a LOW to HIGH transition of SDA when SCL is HIGH. The stop condition is also used by the X24C08 to place the device into the standby power mode after a read sequence. A stop condition can only be issued after the transmitting device has released the bus.

Figure 1. Data Validity

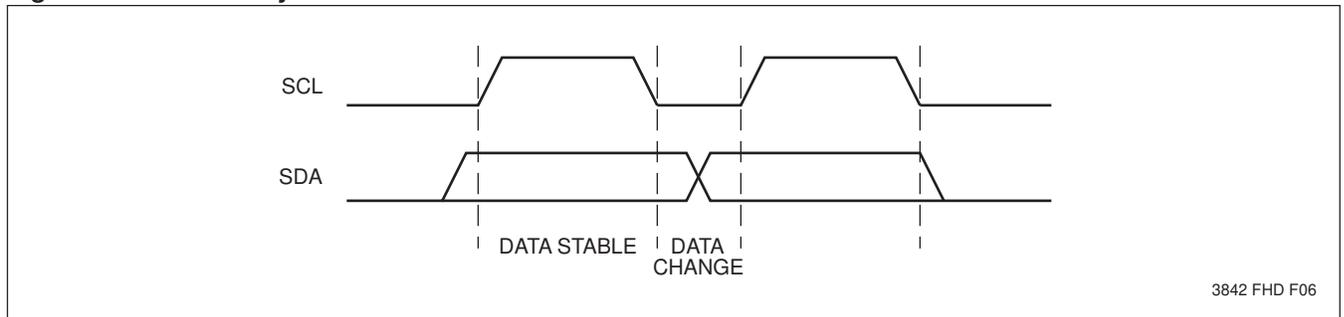
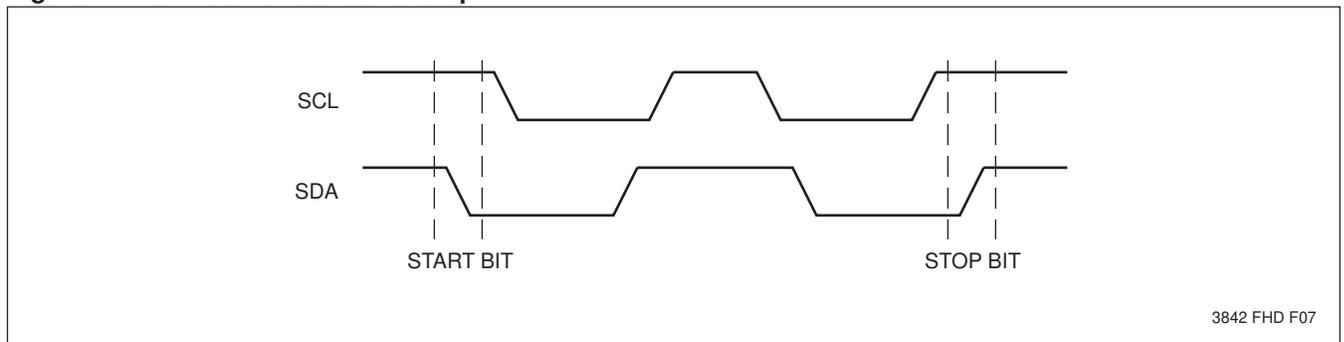


Figure 2. Definition of Start and Stop

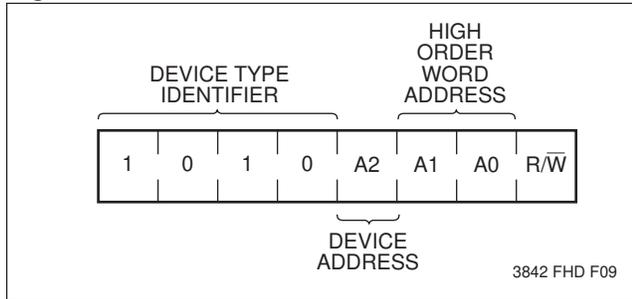


X24C08

DEVICE ADDRESSING

Following a start condition the master must output the address of the slave it is accessing. The most significant four bits of the slave address are the device type identifier (see Figure 4). For the X24C08 this is fixed as 1010[B].

Figure 4. Slave Address



The next bit addresses a particular device. A system could have up to two X24C08 devices on the bus (see Figure 10). The two addresses are defined by the state of the A2 input.

The next two bits of the slave address field are an extension of the array's address and are concatenated with the eight bits of address in the word address field, providing direct access to the whole 1024 x 8 array.

The last bit of the slave address defines the operation to be performed. When set to one a read operation is selected, when set to zero a write operation is selected.

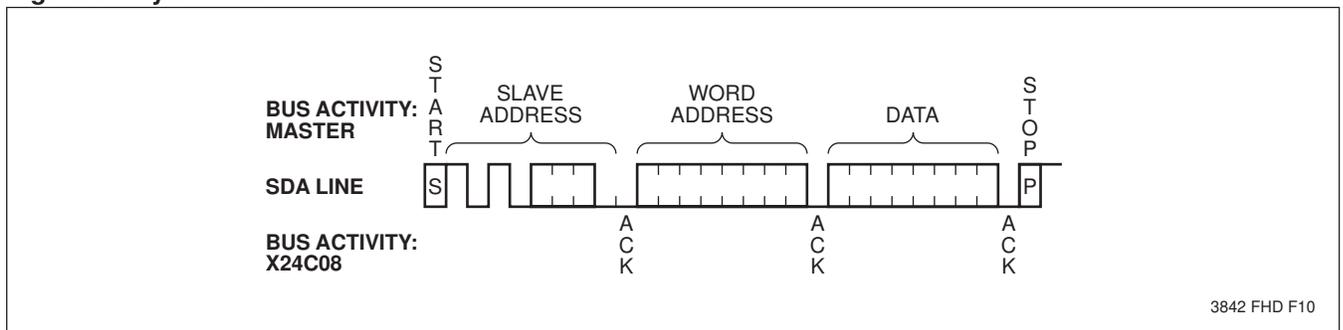
Following the start condition, the X24C08 monitors the SDA bus comparing the slave address being transmitted with its slave address (device type and state of A2 input.) Upon a correct compare the X24C08 outputs an acknowledge on the SDA line. Depending on the state of the R/W bit, the X24C08 will execute a read or write operation.

WRITE OPERATIONS

Byte Write

For a write operation, the X24C08 requires a second address field. This address field is the word address, comprised of eight bits, providing access to any one of 1024 words in the array. Upon receipt of the word address the X24C08 responds with an acknowledge, and awaits the next eight bits of data, again responding with an acknowledge. The master then terminates the transfer by generating a stop condition, at which time the X24C08 begins the internal write cycle to the nonvolatile memory. While the internal write cycle is in progress the X24C08 inputs are disabled, and the device will not respond to any requests from the master. Refer to Figure 5 for the address, acknowledge and data transfer sequence.

Figure 5. Byte Write



X24C08

Page Write

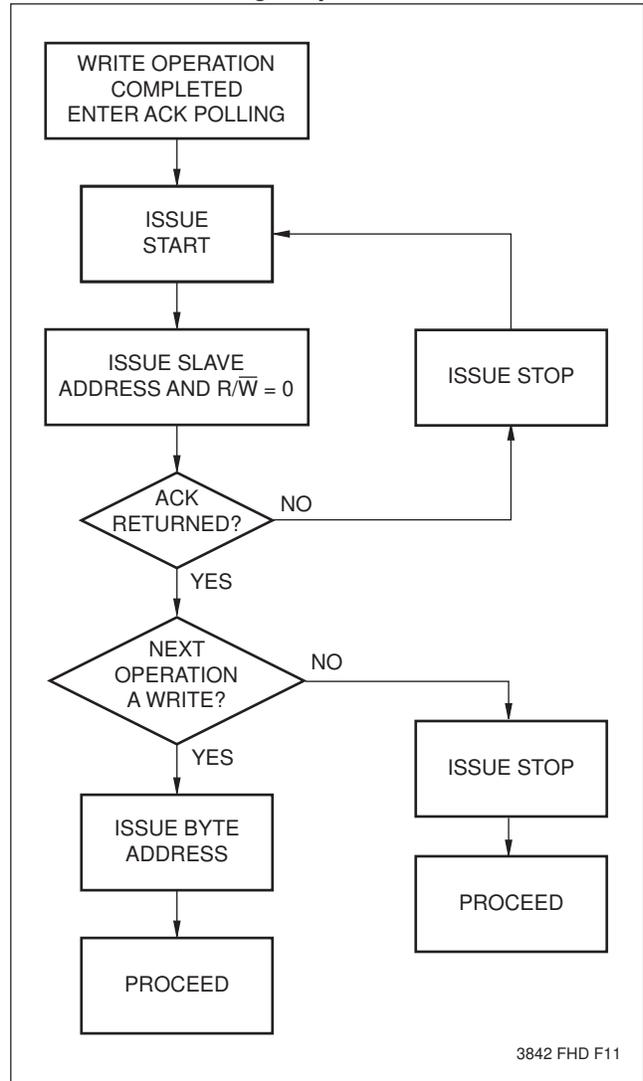
The X24C08 is capable of a sixteen byte page write operation. It is initiated in the same manner as the byte write operation, but instead of terminating the write cycle after the first data word is transferred, the master can transmit up to fifteen more words. After the receipt of each word, the X24C08 will respond with an acknowledge.

After the receipt of each word, the four low order address bits are internally incremented by one. The high order six bits of the word address remain constant. If the master should transmit more than sixteen words prior to generating the stop condition, the address counter will “roll over” and the previously written data will be overwritten. As with the byte write operation, all inputs are disabled until completion of the internal write cycle. Refer to Figure 6 for the address, acknowledge and data transfer sequence.

Acknowledge Polling

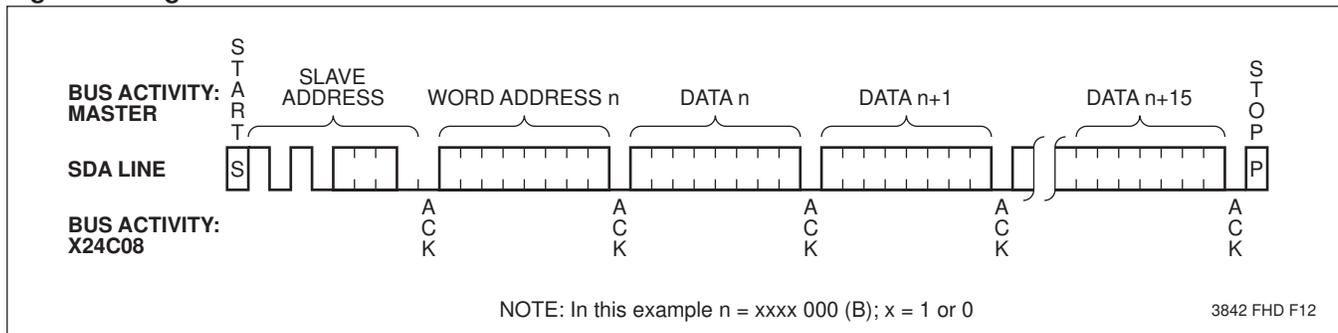
The disabling of the inputs can be used to take advantage of the typical 5 ms write cycle time. Once the stop condition is issued to indicate the end of the host’s write operation the X24C08 initiates the internal write cycle. ACK polling can be initiated immediately. This involves issuing the start condition followed by the slave address for a write operation. If the X24C08 is still busy with the write operation no ACK will be returned. If the X24C08 has completed the write operation an ACK will be returned and the host can then proceed with the next read or write operation. Refer to Flow 1.

Flow 1. ACK Polling Sequence



3842 FHD F11

Figure 6. Page Write



3842 FHD F12

X24C08

READ OPERATIONS

Read operations are initiated in the same manner as write operations with the exception that the $\overline{R/W}$ bit of the slave address is set to a one. There are three basic read operations: current address read, random read and sequential read.

It should be noted that the ninth clock cycle of the read operation is not a “don’t care.” To terminate a read operation, the master must either issue a stop condition during the ninth cycle or hold SDA HIGH during the ninth clock cycle and then issue a stop condition.

Current Address Read

Internally the X24C08 contains an address counter that maintains the address of the last word accessed, incremented by one. Therefore, if the last access (either a read or write) was to address n , the next read operation would access data from address $n + 1$. Upon receipt of the slave address with $\overline{R/W}$ set to one, the X24C08 issues an acknowledge and transmits the eight bit word.

The read operation is terminated by the master; by not responding with an acknowledge and by issuing a stop condition. Refer to Figure 7 for the sequence of address, acknowledge and data transfer.

Random Read

Random read operations allow the master to access any memory location in a random manner. Prior to issuing the slave address with the $\overline{R/W}$ bit set to one, the master must first perform a “dummy” write operation. The master issues the start condition, and the slave address followed by the word address it is to read. After the word address acknowledge, the master immediately reissues the start condition and the slave address with the $\overline{R/W}$ bit set to one. This will be followed by an acknowledge from the X24C08 and then by the eight bit word. The read operation is terminated by the master; by not responding with an acknowledge and by issuing a stop condition. Refer to Figure 8 for the address, acknowledge and data transfer sequence.

Figure 7. Current Address Read

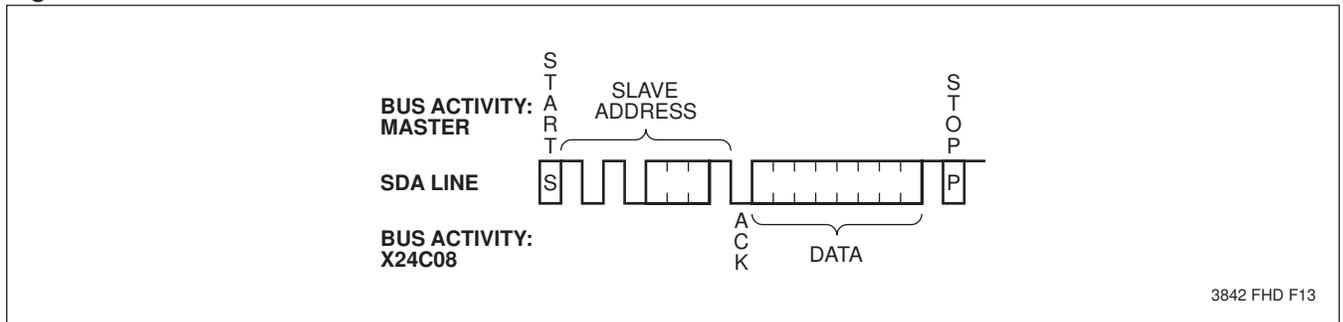
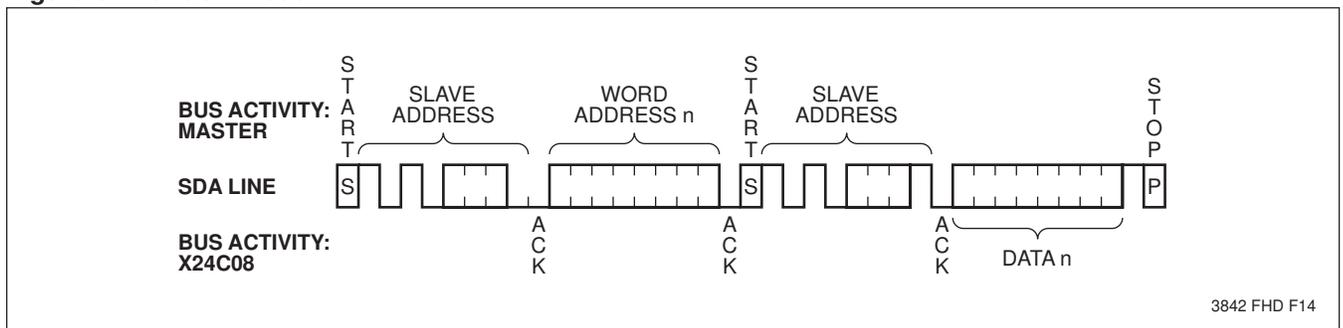


Figure 8. Random Read



X24C08

Sequential Read

Sequential reads can be initiated as either a current address read or random access read. The first word is transmitted as with the other read modes; however, the master now responds with an acknowledge, indicating it requires additional data. The X24C08 continues to output data for each acknowledge received. The read operation is terminated by the master; by not responding with an acknowledge and by issuing a stop condition.

The data output is sequential, with the data from address n followed by the data from $n + 1$. The address counter for read operations increments all address bits, allowing the entire memory contents to be serially read during one operation. At the end of the address space (address 1023) the counter “rolls over” to address 0 and the X24C08 continues to output data for each acknowledge received. Refer to Figure 9 for the address, acknowledge and data transfer sequence.

Figure 9. Sequential Read

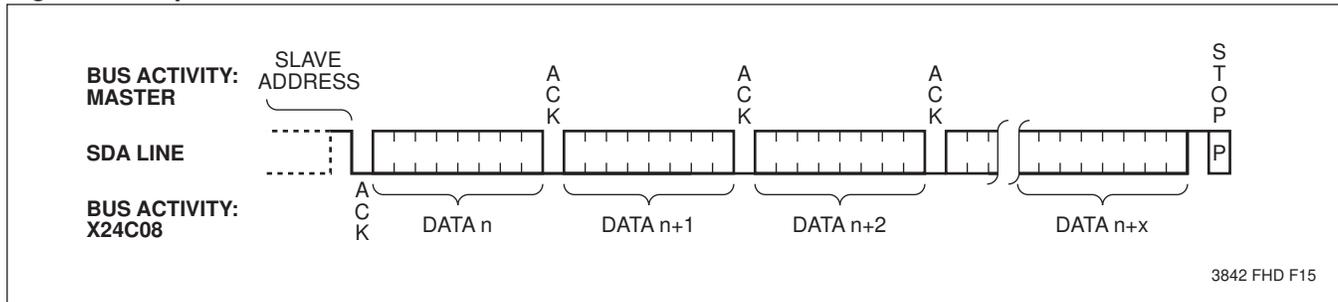
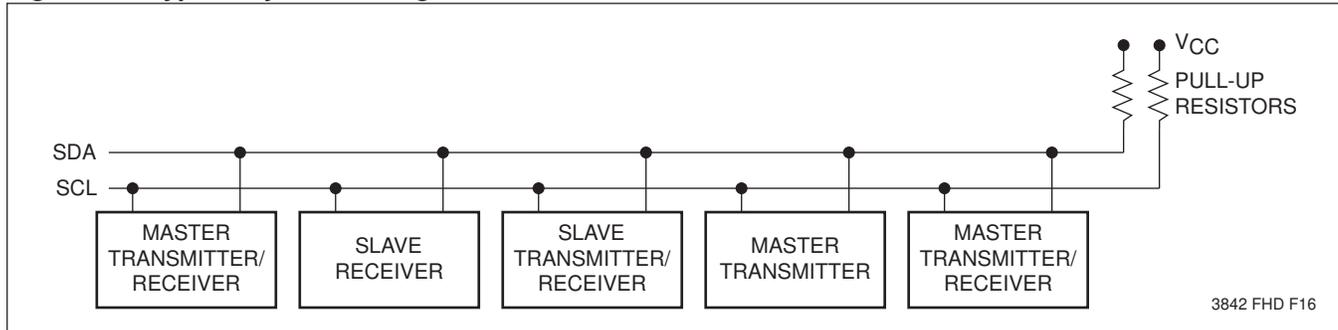


Figure 10. Typical System Configuration



X24C08

ABSOLUTE MAXIMUM RATINGS*

Temperature Under Bias	-65°C to +135°C
Storage Temperature	-65°C to +150°C
Voltage on any Pin with Respect to V_{SS}	-1.0V to +7V
D.C. Output Current	5 mA
Lead Temperature (Soldering, 10 Seconds)	300°C

*COMMENT

Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and the functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Temperature	Min.	Max.
Commercial	0°C	70°C
Industrial	-40°C	+85°C
Military	-55°C	+125°C

Supply Voltage	Limits
X24C08	4.5V to 5.5V
X24C08-3.5	3.5V to 5.5V
X24C08-3	3V to 5.5V
X24C08-2.7	2.7V to 5.5V

D.C. OPERATING CHARACTERISTICS (Over recommended operating conditions, unless otherwise specified.)

Symbol	Parameter	Limits		Units	Test Conditions
		Min.	Max.		
I_{CC1}	V_{CC} Supply Current (Read)		1	mA	SCL = $V_{CC} \times 0.1/V_{CC} \times 0.9$ Levels @ 100 KHz, SDA = Open, All Other Inputs = GND or $V_{CC} - 0.3V$
I_{CC2}	V_{CC} Supply Current (Write)		3		
$I_{SB1}^{(1)}$	V_{CC} Standby Current		150	μA	SCL = SDA = $V_{CC} - 0.3V$, All Other Inputs = GND or V_{CC} , $V_{CC} = 5.5V$
$I_{SB2}^{(1)}$	V_{CC} Standby Current		50	μA	SCL = SDA = $V_{CC} - 0.3V$, All Other Inputs = GND or V_{CC} , $V_{CC} = 3V$
I_{LI}	Input Leakage Current		10	μA	$V_{IN} = GND$ to V_{CC}
I_{LO}	Output Leakage Current		10	μA	$V_{OUT} = GND$ to V_{CC}
$V_{IL}^{(2)}$	Input Low Voltage	-1.0	$V_{CC} \times 0.3$	V	
$V_{IH}^{(2)}$	Input High Voltage	$V_{CC} \times 0.7$	$V_{CC} + 0.5$	V	
V_{OL}	Output Low Voltage		0.4	V	$I_{OL} = 3$ mA

3842 PGM T02

CAPACITANCE $T_A = 25^\circ C$, $F = 1.0MHz$, $V_{CC} = 5V$

Symbol	Test	Max.	Units	Conditions
$C_{I/O}^{(3)}$	Input/Output Capacitance (SDA)	8	pF	$V_{I/O} = 0V$
$C_{IN}^{(3)}$	Input Capacitance (A_0, A_1, A_2, SCL)	6	pF	$V_{IN} = 0V$

3842 PGM T04

- Notes:** (1) Must perform a stop command prior to measurement.
 (2) V_{IL} min and V_{IH} max. are for reference only and are not 100% tested.
 (3) This parameter is periodically sampled and not 100% tested.

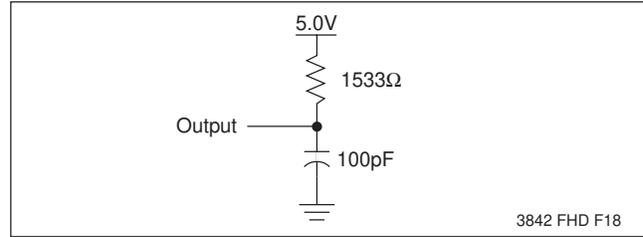
X24C08

A.C. CONDITIONS OF TEST

Input Pulse Levels	$V_{CC} \times 0.1$ to $V_{CC} \times 0.9$
Input Rise and Fall Times	10ns
I/O Timing Levels	$V_{CC} \times 0.5$

3842 PGM T05

EQUIVALENT A.C. LOAD CIRCUIT



3842 FHD F18

A.C. CHARACTERISTICS LIMITS (Over recommended operating conditions, unless otherwise specified.)

Read & Write Cycle Limits

Symbol	Parameter	Min.	Max.	Units
t_{SCL}	SCL Clock Frequency	0	100	KHz
t_i	Noise Suppression Time Constant at SCL, SDA Inputs		100	ns
t_{AA}	SCL Low to SDA Data Out Valid	0.3	3.5	μ s
t_{BUF}	Time the Bus Must Be Free Before a New Transmission Can Start	4.7		μ s
$t_{HD:STA}$	Start Condition Hold Time	4.0		μ s
t_{LOW}	Clock Low Period	4.7		μ s
t_{HIGH}	Clock High Period	4.0		μ s
$t_{SU:STA}$	Start Condition Setup Time	4.7		μ s
$t_{HD:DAT}$	Data In Hold Time	0		μ s
$t_{SU:DAT}$	Data In Setup Time	250		ns
t_R	SDA and SCL Rise Time		1	μ s
t_F	SDA and SCL Fall Time		300	ns
$t_{SU:STO}$	Stop Condition Setup Time	4.7		μ s
t_{DH}	Data Out Hold Time	300		ns

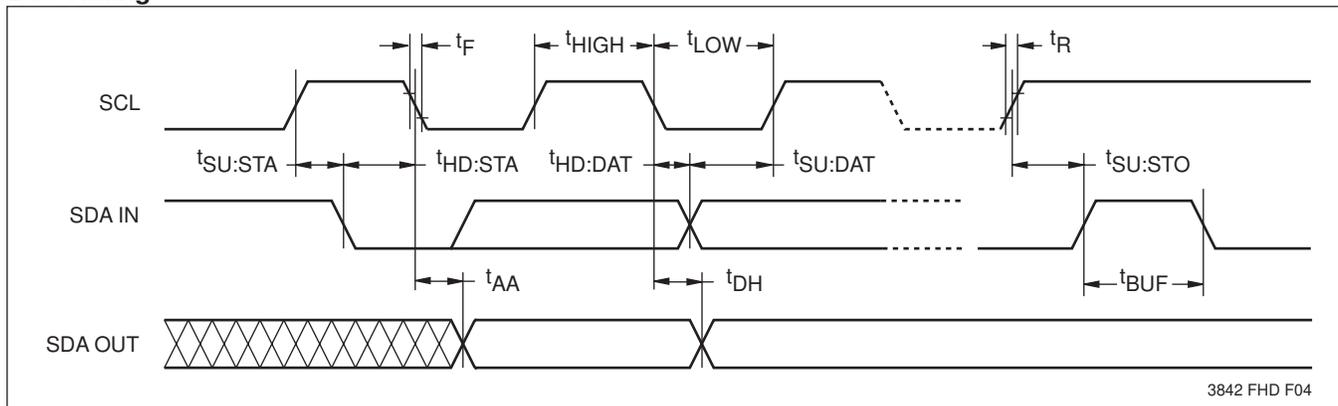
3842 PGM T06

POWER-UP TIMING

Symbol	Parameter	Max.	Units
$t_{PUR}^{(4)}$	Power-Up to Read Operation	1	ms
$t_{PUW}^{(4)}$	Power-Up to Write Operation	5	ms

3842 PGM T07

Bus Timing



3842 FHD F04

Note: (4) t_{PUR} and t_{PUW} are the delays required from the time V_{CC} is stable until the specified operation can be initiated. These parameters are periodically sampled and not 100% tested.

X24C08

WRITE CYCLE LIMITS

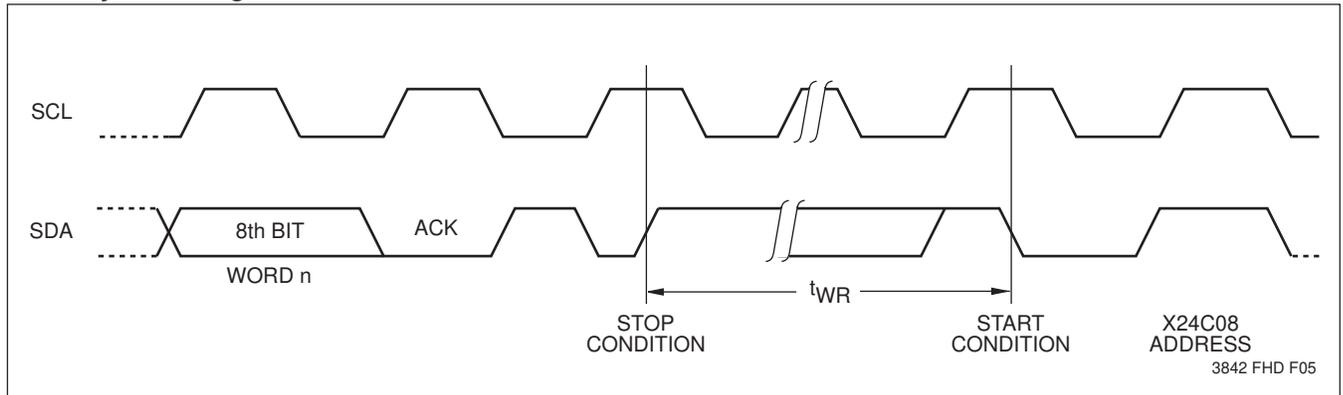
Symbol	Parameter	Min.	Typ. ⁽⁵⁾	Max.	Units
$t_{WR}^{(6)}$	Write Cycle Time		5	10	ms

3842 PGM T08

The write cycle time is the time from a valid stop condition of a write sequence to the end of the internal erase/program cycle. During the write cycle, the X24C08

bus interface circuits are disabled, SDA is allowed to remain high, and the device does not respond to its slave address.

Write Cycle Timing

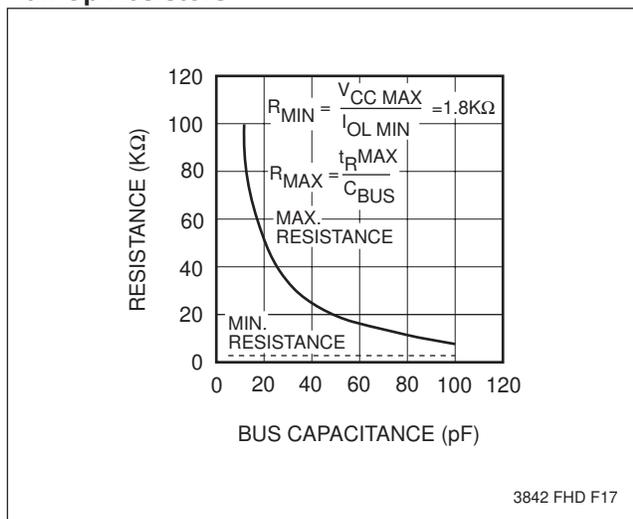


3842 FHD F05

Notes: (5) Typical values are for $T_A = 25^\circ\text{C}$ and nominal supply voltage (5V).

(6) t_{WR} is the minimum cycle time from the system perspective when polling techniques are not used. It is the maximum time the device requires to perform the internal write operation.

Guidelines for Calculating Typical Values of Bus Pull-Up Resistors



SYMBOL TABLE

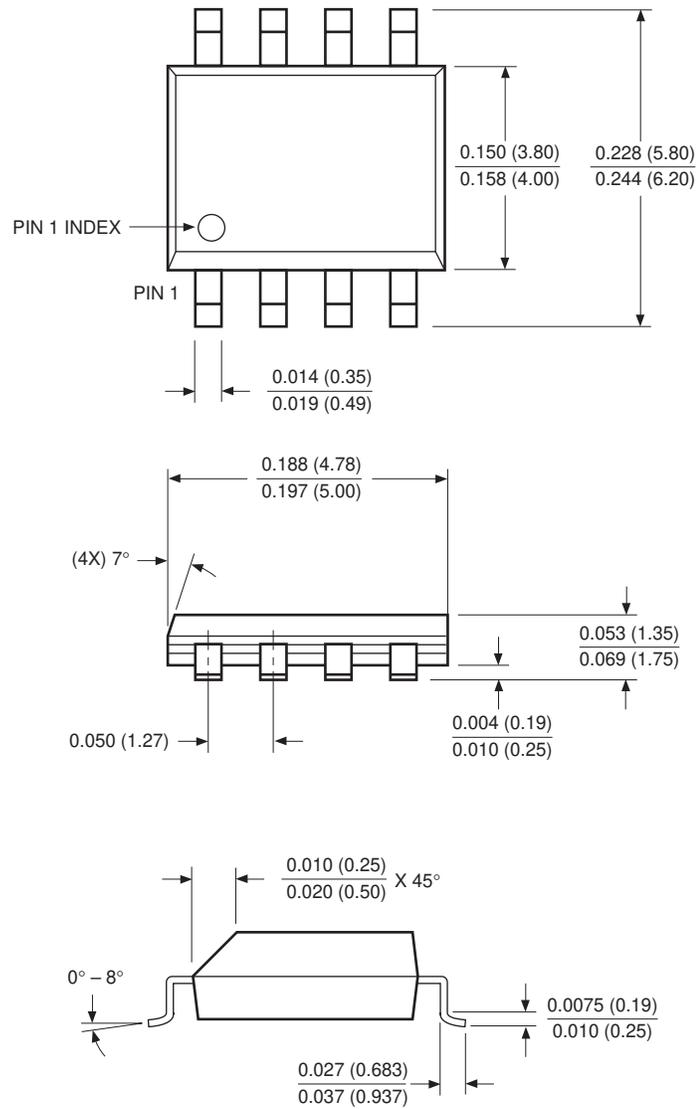
WAVEFORM	INPUTS	OUTPUTS
	Must be steady	Will be steady
	May change from Low to High	Will change from Low to High
	May change from High to Low	Will change from High to Low
	Don't Care: Changes Allowed	Changing: State Not Known
	N/A	Center Line is High Impedance

NOTES

X24C08

PACKAGING INFORMATION

8-LEAD PLASTIC SMALL OUTLINE GULL WING PACKAGE TYPE S



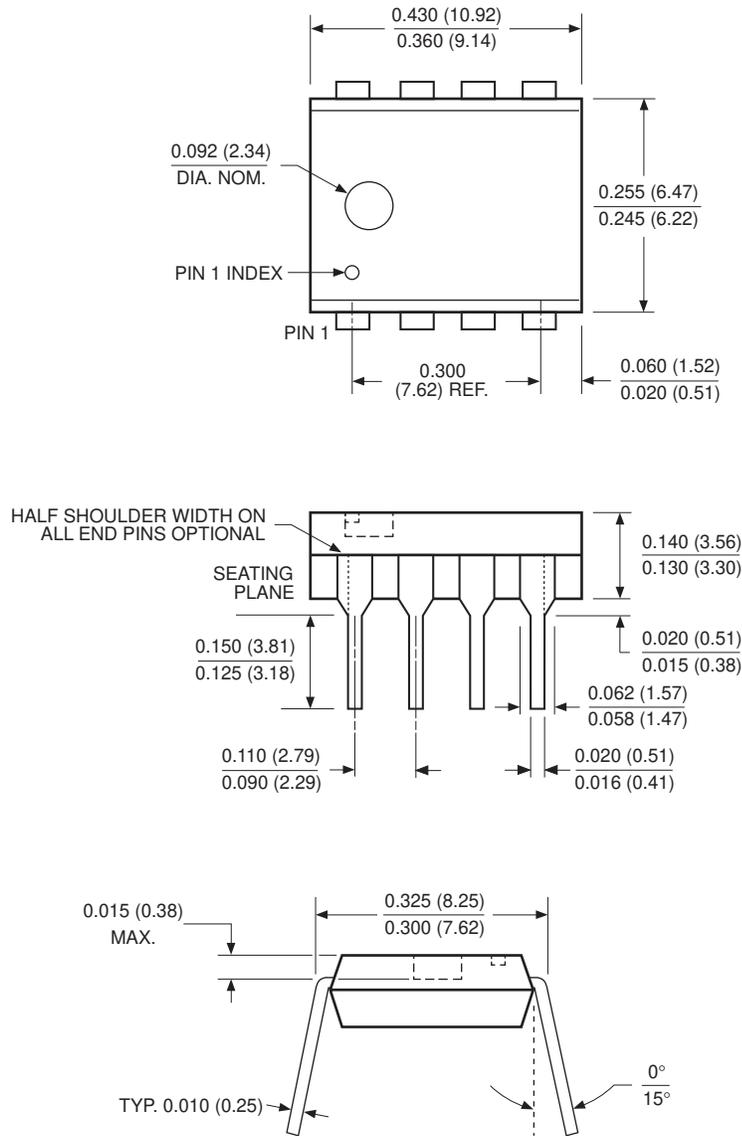
NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESIS IN MILLIMETERS)

3926 FHD F22

X24C08

PACKAGING INFORMATION

8-LEAD PLASTIC DUAL IN-LINE PACKAGE TYPE P



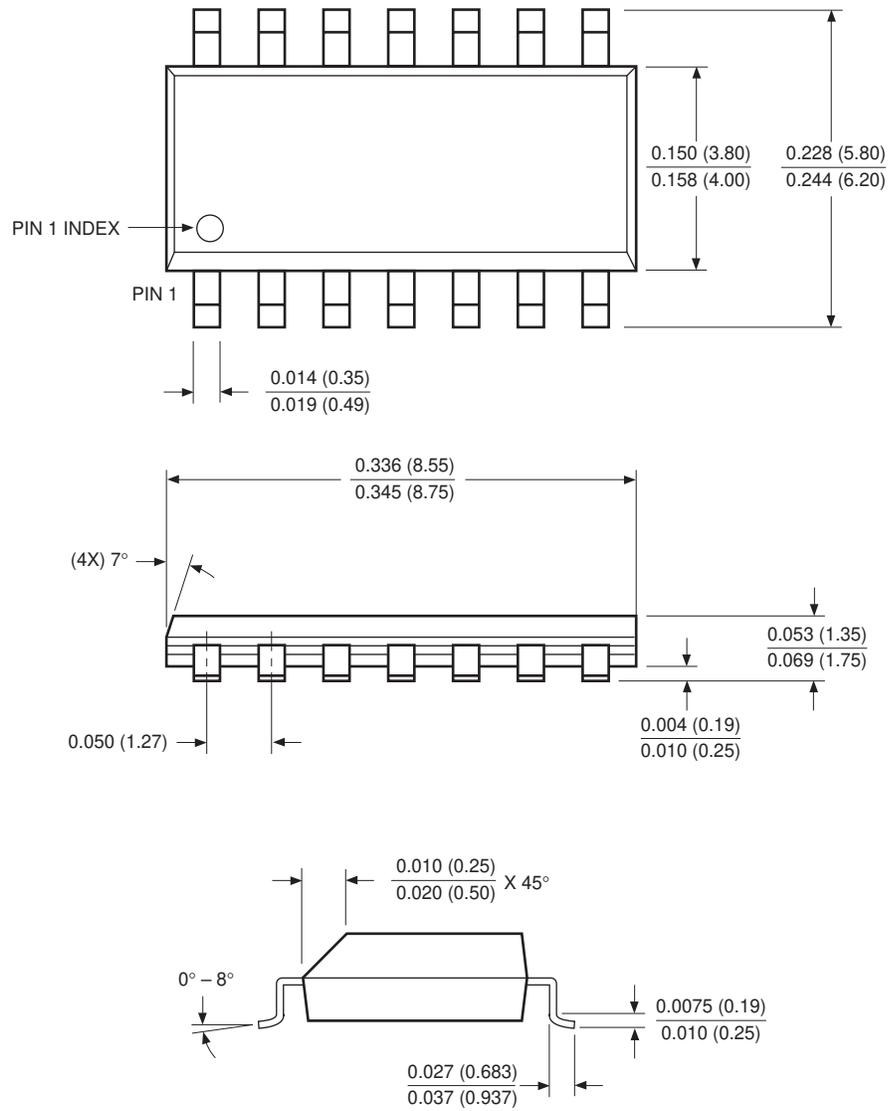
NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

3926 FHD F01

X24C08

PACKAGING INFORMATION

14-LEAD PLASTIC SMALL OUTLINE GULL WING PACKAGE TYPE S

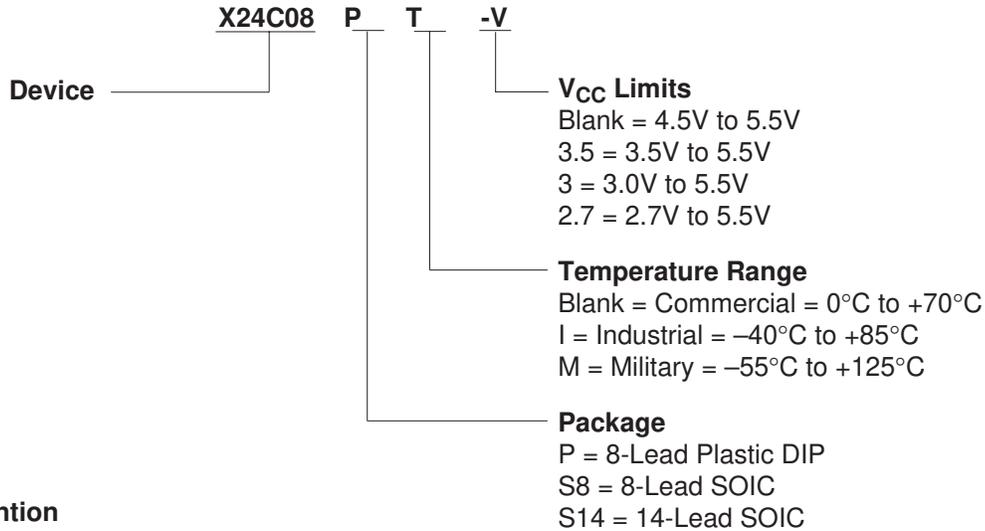


NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

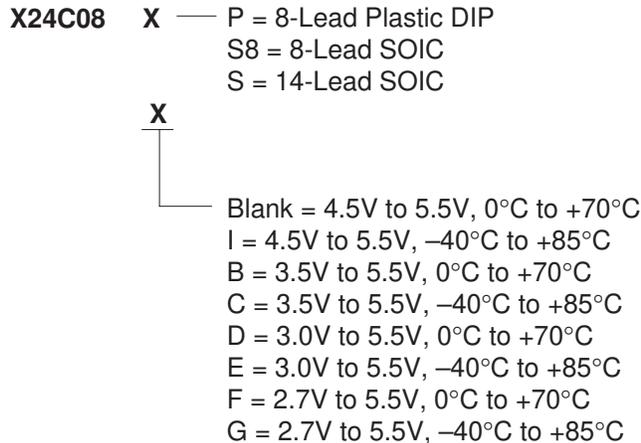
3926 FHD F10

X24C08

ORDERING INFORMATION



Part Mark Convention



LIMITED WARRANTY

Devices sold by Xicor, Inc. are covered by the warranty and patent indemnification provisions appearing in its Terms of Sale only. Xicor, Inc. makes no warranty, express, statutory, implied, or by description regarding the information set forth herein or regarding the freedom of the described devices from patent infringement. Xicor, Inc. makes no warranty of merchantability or fitness for any purpose. Xicor, Inc. reserves the right to discontinue production and change specifications and prices at any time and without notice.

Xicor, Inc. assumes no responsibility for the use of any circuitry other than circuitry embodied in a Xicor, Inc. product. No other circuits, patents, licenses are implied.

U.S. PATENTS

Xicor products are covered by one or more of the following U.S. Patents: 4,263,664; 4,274,012; 4,300,212; 4,314,265; 4,326,134; 4,393,481; 4,404,475; 4,450,402; 4,486,769; 4,488,060; 4,520,461; 4,533,846; 4,599,706; 4,617,652; 4,668,932; 4,752,912; 4,829, 482; 4,874, 967; 4,883, 976. Foreign patents and additional patents pending.

LIFE RELATED POLICY

In situations where semiconductor component failure may endanger life, system designers using this product should design the system with appropriate error detection and correction, redundancy and back-up features to prevent such an occurrence.

Xicor's products are not authorized for use in critical components in life support devices or systems.

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

This datasheet has been downloaded from:

www.DatasheetCatalog.com

Datasheets for electronic components.